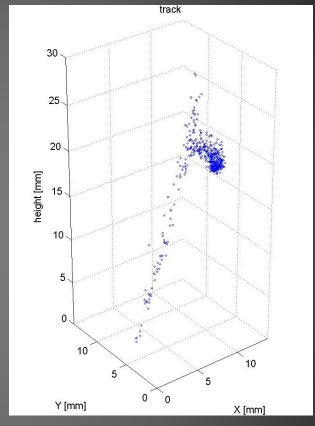


Data Compression and LVL1 track triggering by means of Digital Signal Processing in GridPix/Gossip FE pixel chips

- Introduction GridPix/Gossip
- GridPix as LVL 1 trigger in ATLAS
- IfLink
- Conclusions



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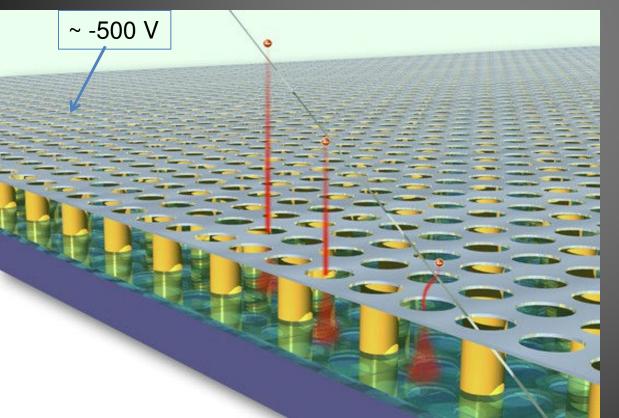
¹ Nikhef

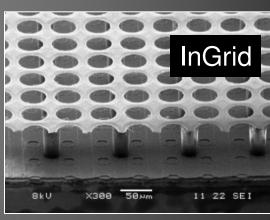
² Radboud University, Nijmegen

³ CERN

Functioning GridPix/Gossip

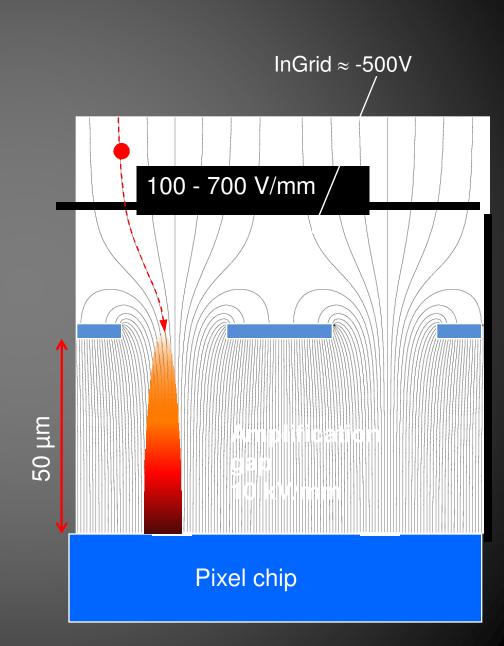
- Gaseous Pixel detector using a pixel chip
 - Using gas as a detecting medium
- Electron from traversing particle drifts towards Micromegas grid and is focused into one of the holes
- Thereafter a gas avalanche is induced ending at the anode pad of the pixel chip





Field configuration of GridPix/Gossip

- Drift field 100 -700 V/mm
- High amplification field under grid to induce gas avalanche
 - ~ 10 kV/mm
- Micromegas holes centred on pads pixel chip
- Avalanche broadened by diffusion to 15 – 20 μm



4.00-

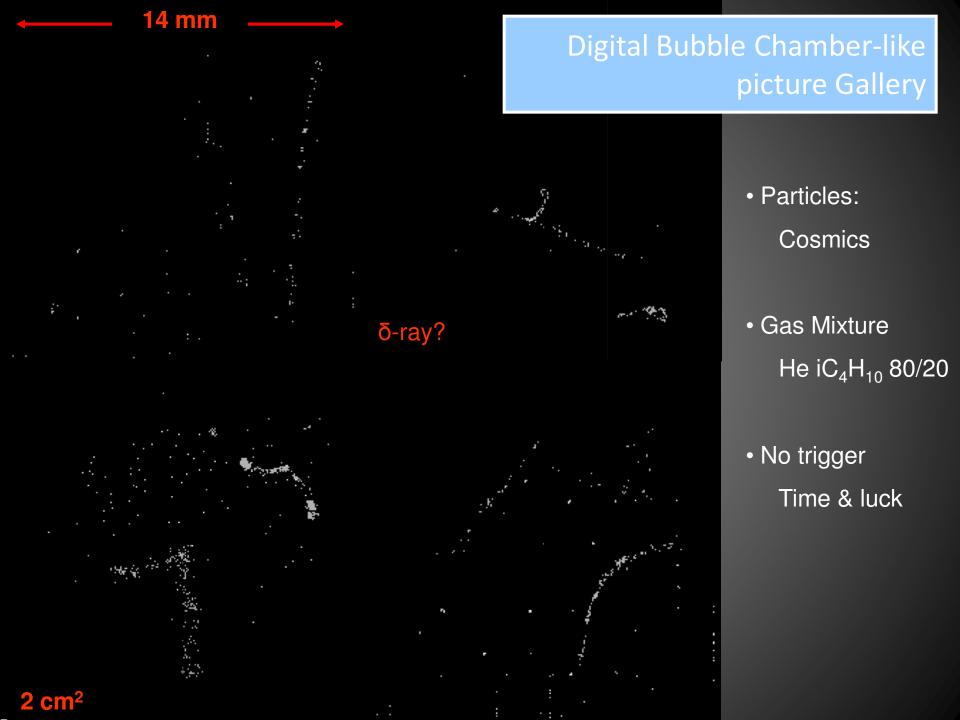
3.00-

2.00-

MIPS

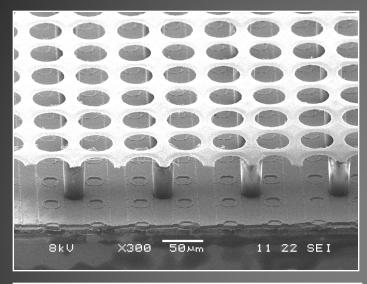
0.00⁻²

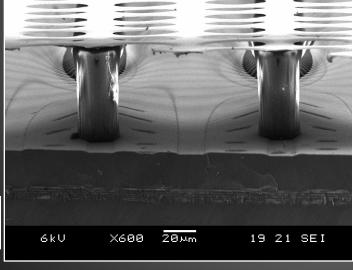
He/Isobutane 80/20 Modified MediPix

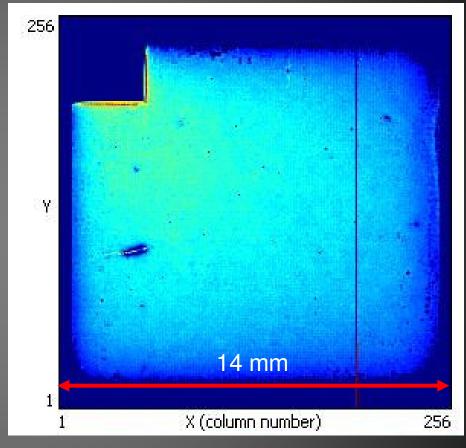


Full post-processing of a TimePix

Timepix chip + SiProt + Ingrid:







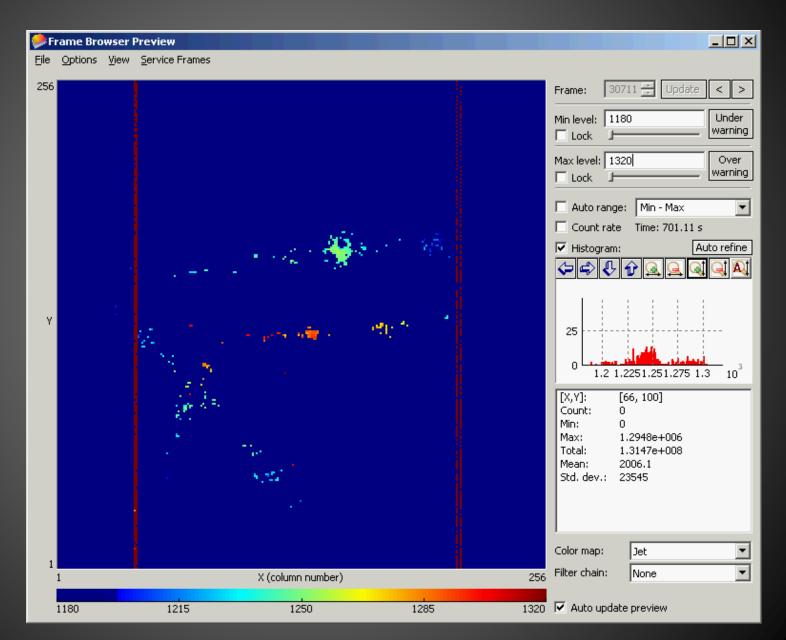
"Uniform"

Charge mode

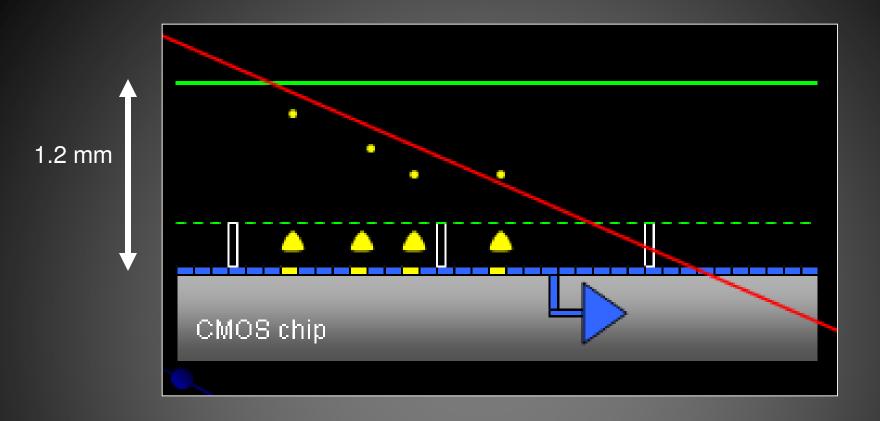
MESA+

IMT Neuchatel

Cosmic rays in Argon



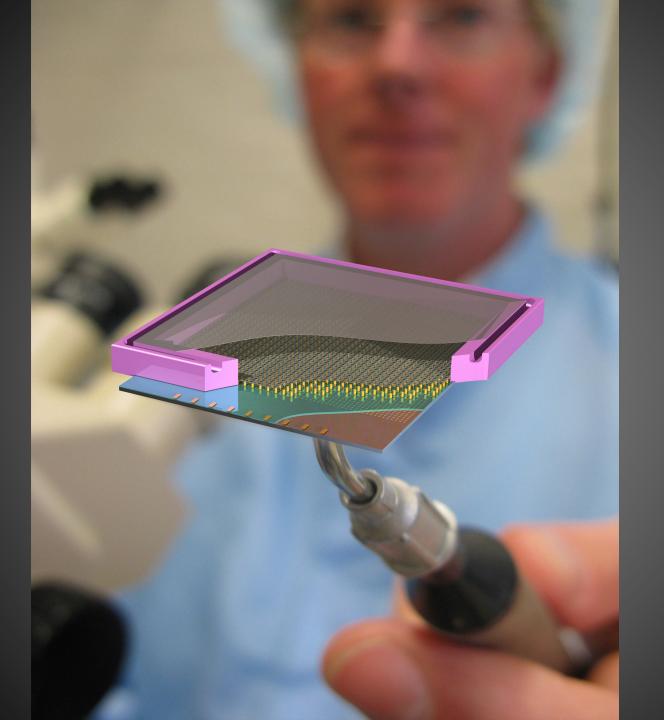
Time mode



Gas On Slimmed Sllicon Pixels

Gossip: replacement of Si tracker

Essential: thin gas layer (1.2 mm)



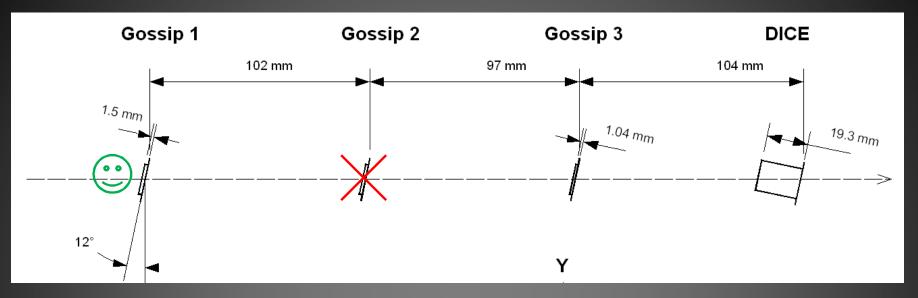
Gas instead of Si Pro:

- no radiation damage in sensor: gas is exchanged
- modest pixel (analog) input circuitry: low power, little space
- no bias current: simple input circuit
- low detector material budget: 0.06 % radiation length/layer typical: Si foil. New mechanical concepts
- low power dissipation: little FE power (2 µW/pixel); no bias dissipation
- operates at room temperature (but other temperatures are OK)
- less sensitive for neutron and X-ray background
- 3D track info per layer if drift time is measured
- gas is cheap (and very cheap wrt. Si sensors!), and light

Con

- Gaseous chamber: discharges (sparks): destroy CMOS chip
- gas-filled proportional chamber: 'chamber ageing'
- Needs gas flow
- Parallax error: 1 ns drift time measurement may be required
- diffusion of (drifting) electrons in gas limit spatial resolution

Test beam experiment using DME/CO₂

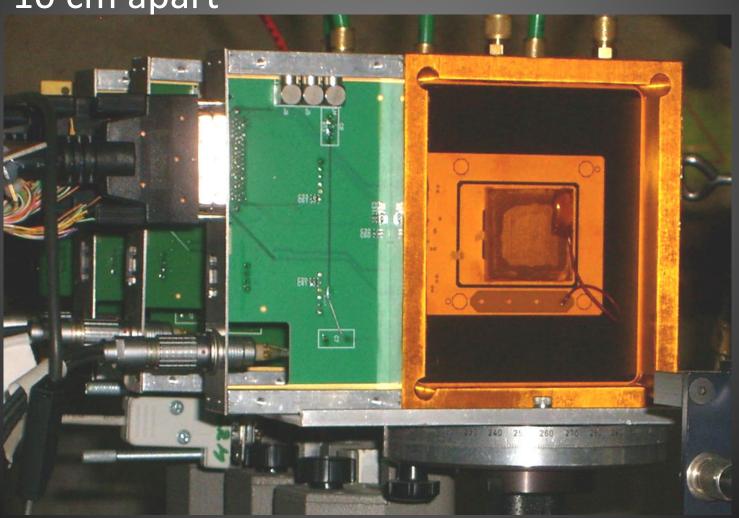


- Beam T10 (6 GeV π) at PS
- 4 detectors ~ 10 cm apart under 12 14° in Y and perpendicular in X
- HV problems (sparking)
 - Gossip 1: gas gap 1.5 mm, good single electron efficiency, protected with GlobTop
 - Gossip 2: not useful (HV problems)
 - Gossip 3: gas gap 1.04 mm, very small single electron efficiency (~ 16%)
 - DICE: gas gap 19.4 mm, single electron efficiency ~ 38%, but good for tracking
- Gas CO₂/DME 50/50

Testbeam setup in T10 (East hall)

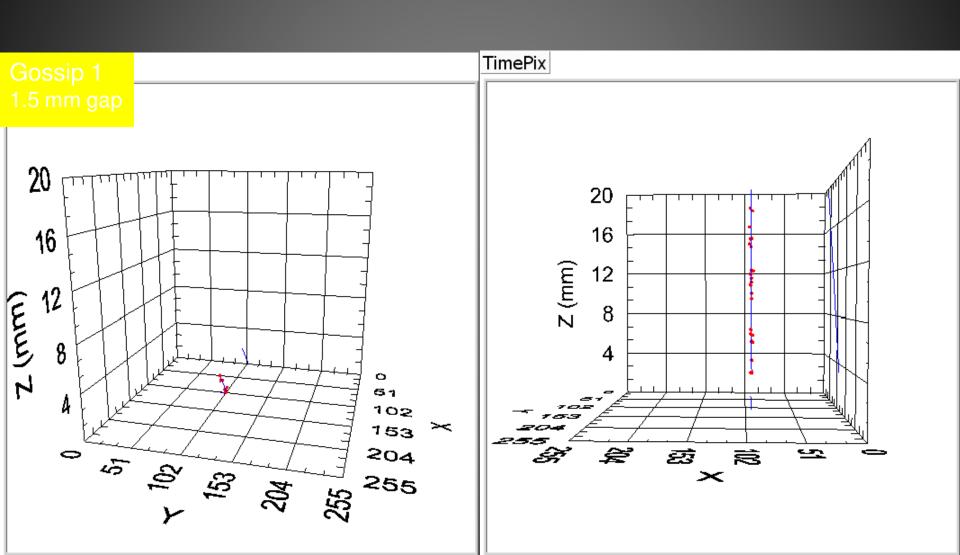
3 Gossips and one GridPix

~ 10 cm apart



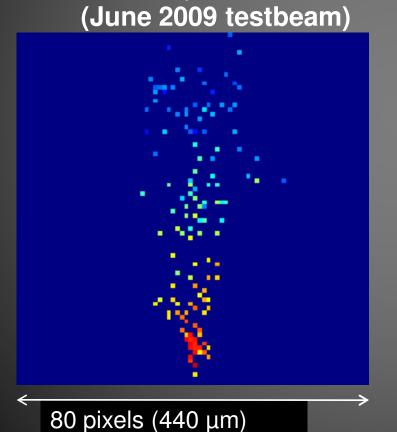
Example of events in Gossip 1 and DICE

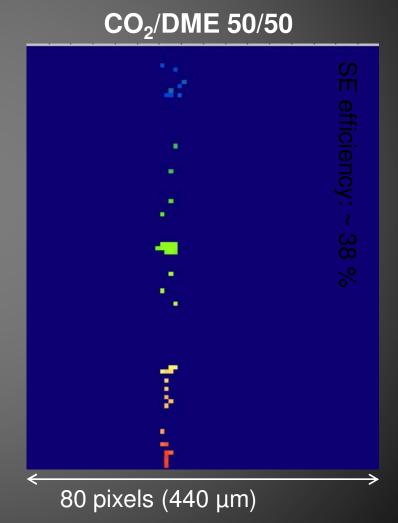
Pixel chip on X-Y plane



Comparing DME/CO₂ with Ar/iC₄H₁₀

- Projected slanting tracks
- Measured in DICE detector: drift distance 19.3 mm
- Very low diffusion for CO_2/DME Ar/iC_4H_{10} 80/20





The MediPix2 pixel CMOS chip

256 x 256 pixels pixel: 55 x 55 µm²

per pixel: - pr

- preamp

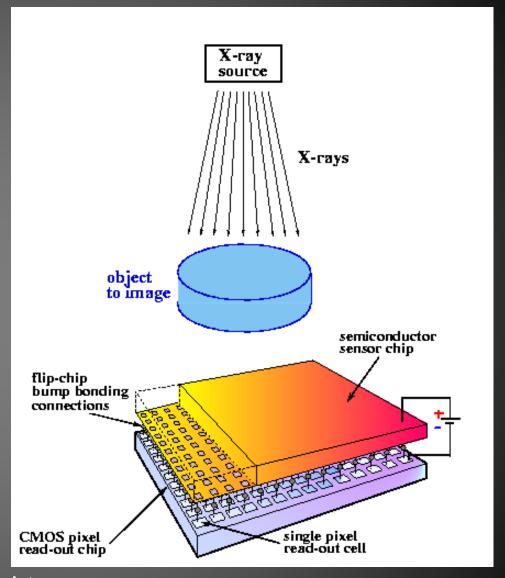
- shaper

- 2 discr.

- Thresh. DAQ

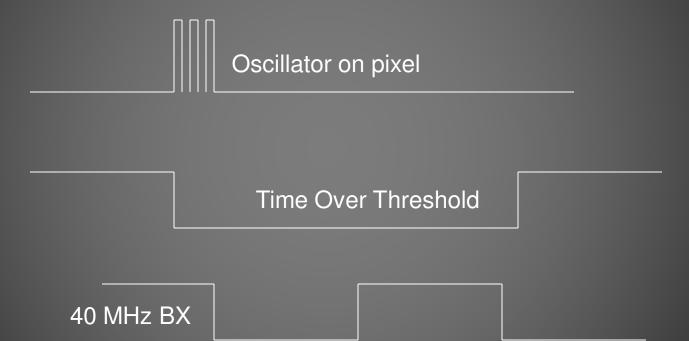
- 14 bit counter

- enable counting
- stop counting
- readout image frame
- reset



We apply the 'naked' MediPix2 chip without X-ray convertor!

1 ns TDC per pixel



TimePix-2

Medipix-1

Medipix-2

250 nm technology

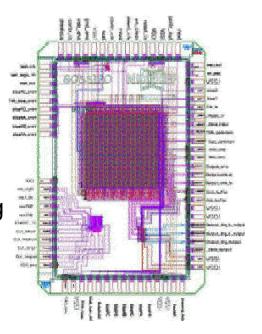
TimePix

Medipix-3
130 nm technology
TimePix-2

Gossipo-2 MPW

600 MHz osc in each pixel

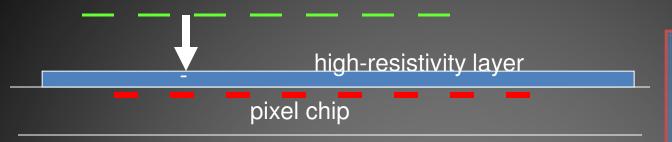
Low-noise, low power analog input



TimePix-2:

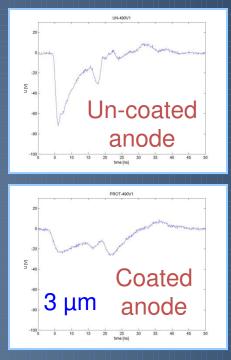
- TDC per pixel: $\sigma = 1$ ns
- 'ADC' per pixel: TimeOverThreshold
- noise: 80 e- eq.
- discharge protection circuit
- fast (trigger enabled) readout

Essentially ALL info on primary electrons in gas is extracted!



SiProt protection against:

- hot spark plasma
- Too large charge in pixel circuitry [principle of RPCs]
 - local reduction of E-field: quenching
 - widening discharge funnel: signal dilution
 - increased distance of 'influention'



SiProt: a low T deposited hydrogenated amorphous silicon (aSi:H) layer

Up to 50 μ m thick films, ~10¹¹ Ω .cm

... discharges are observed!

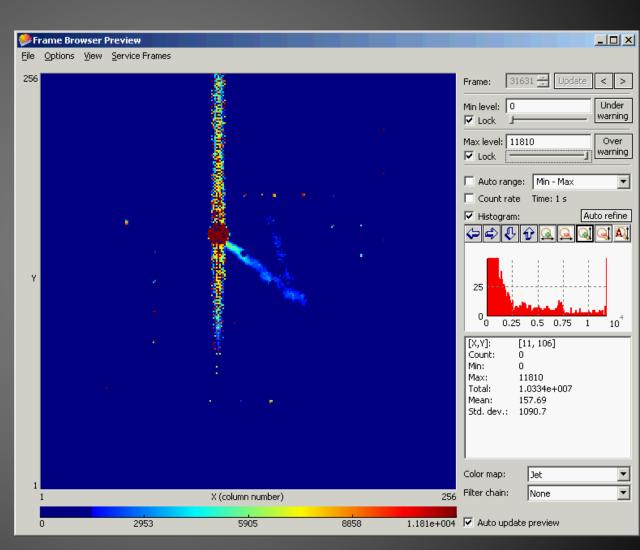
For the 1st time: image of discharges are being recorded

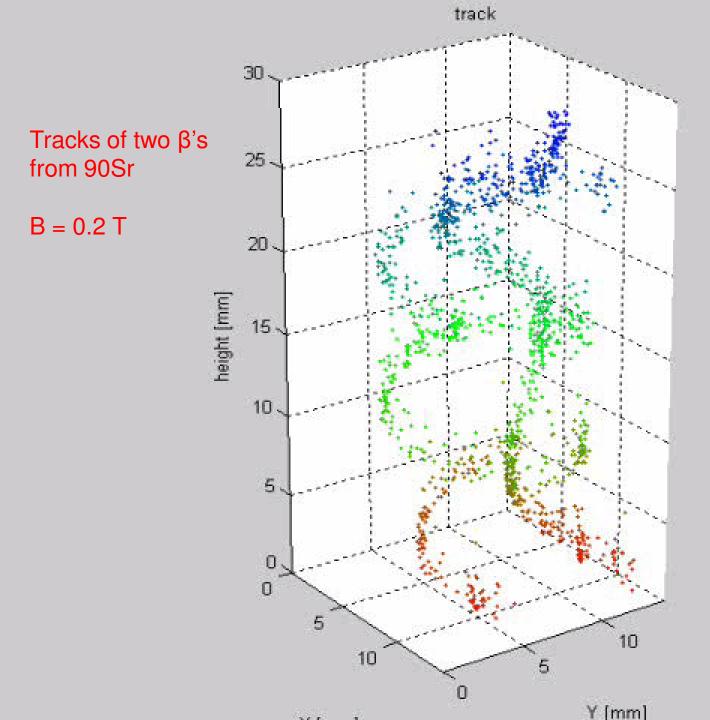
Round-shaped pattern of some 100 overflow pixels

Perturbations in the concerned column pixels

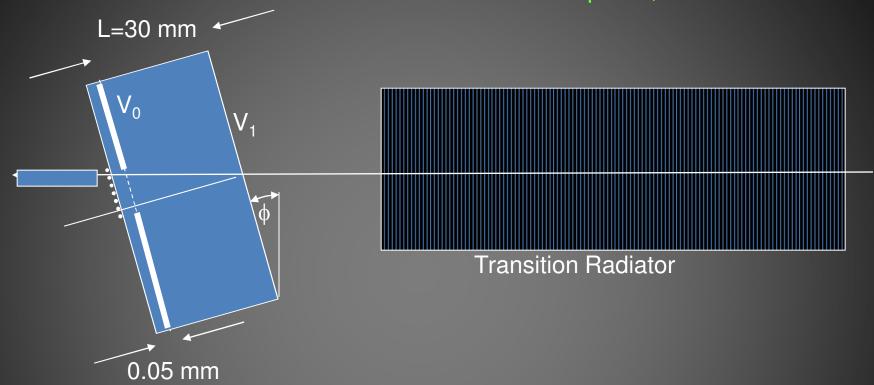
- Threshold
- Power

Chip keeps working





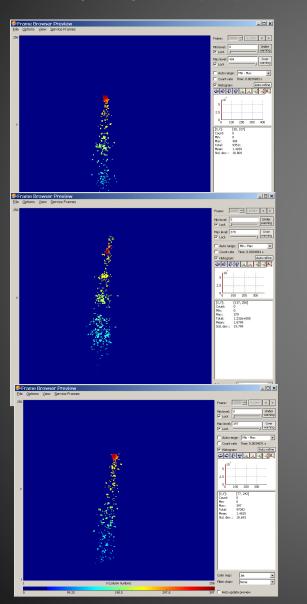
Testbeam Nov 5 - 12, 2007 PS/T9: electrons and pions, 1 - 15 GeV/c

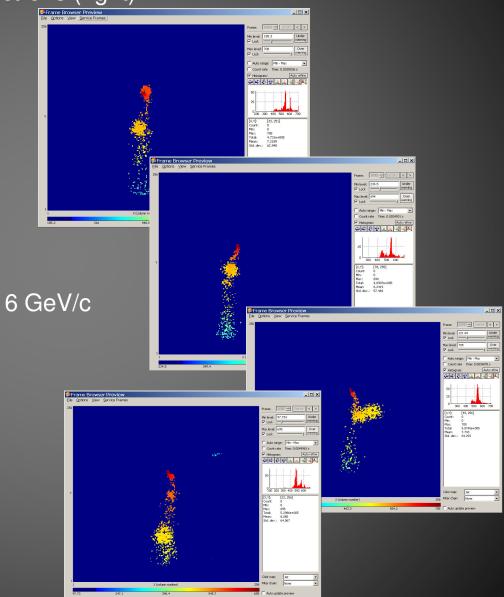


Anatoli Romaniouk, Serguei Morozov, Serguei Konovalov Martin Fransen, Fred Hartjes, Max Chefdeville, Victor Blanco Carballo

Particle Identification

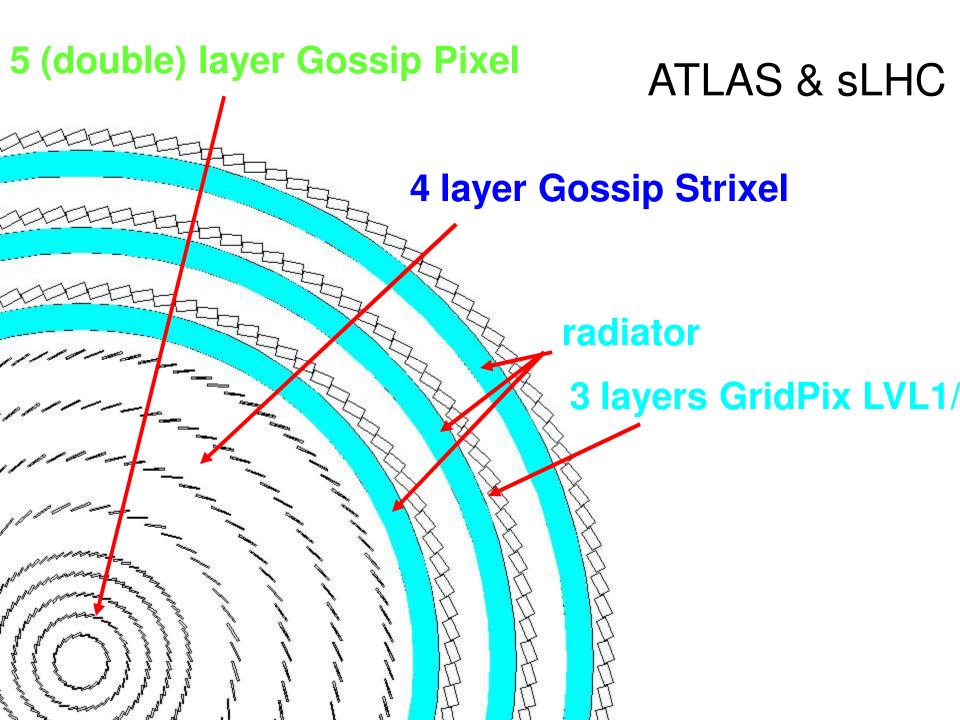
Samples pions (left) and electrons (right)





Status of GridPix/Gossip

- Priority 1: Chip destruction must be stopped
- low-cost mass production to be demonstrated (SMC in Edinburgh, UK, and IZM Berlin, Germany)
- Review by ATLAS Upgrade commission coming Monday, Tuesday

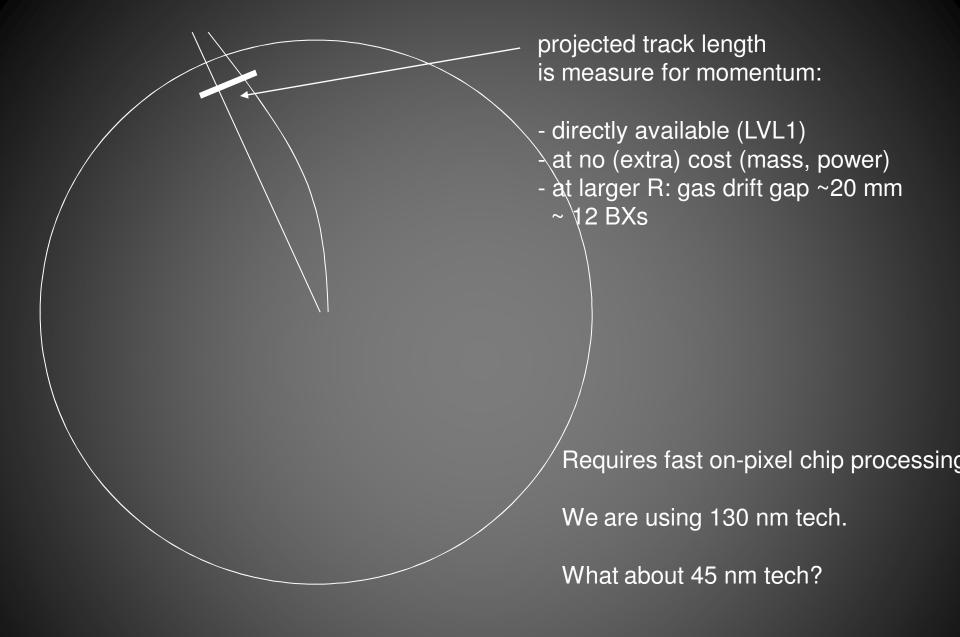


Double (Si) layers

Two points:
Track segment (vector)

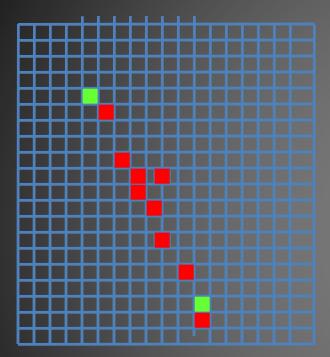
Requires inter-pixel chip communication, or data transport to common correlation processor

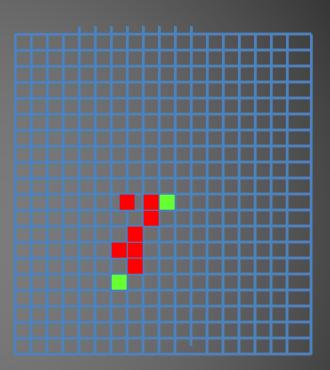
Gossip measures track segment vector in single layer



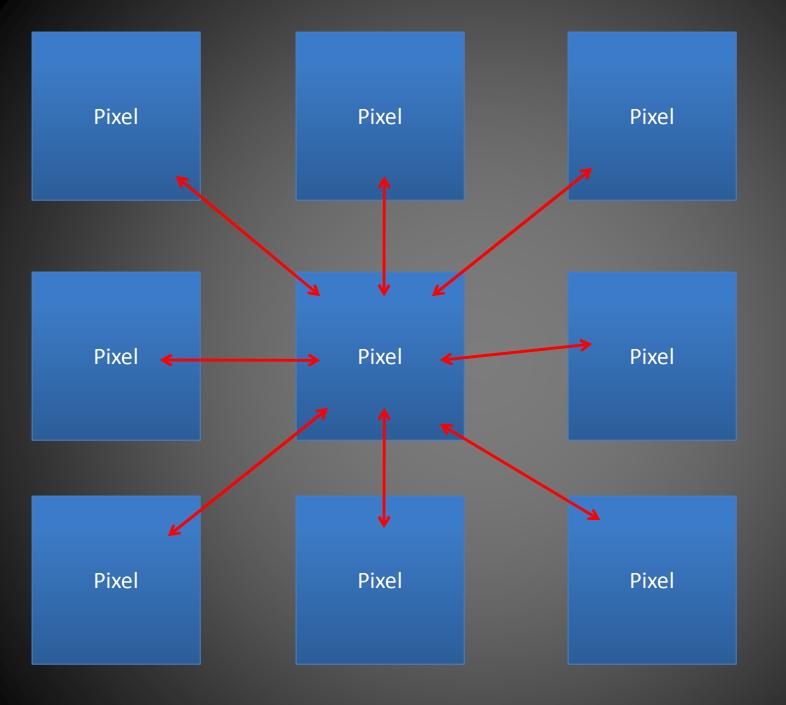
LVL1 trigger from inner tracker

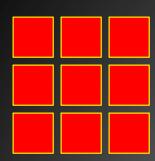
Length of projected track is direct measure for momentum





Endpoint Annihilation





Goals of algoritm: find projected track length well within 1 μ s, possible within \sim 10 ns.

- pixel: am I hit?
 - -I may be part of a track
- is my neighbour hit?
- if two neighbours are hit I am probably not an endpoint
- if only one neighbourt is hit I may be an endpoint
- if there is another endpoint near me we should probably merge and annihilate
- Very unlikely to have two min. bias events on one chip

Large problem: projected tracks not contained in one chip

- at least two trigger LVL1 layers (maybe many more!)
- can be solved if 'endpoint' data can be processed externally

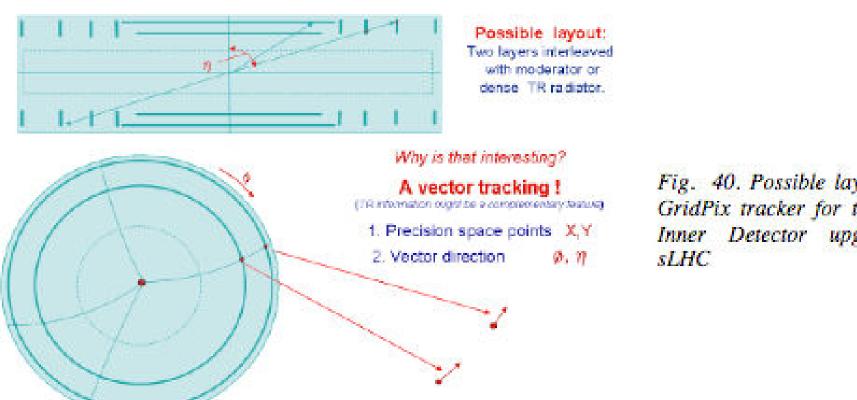


Fig. 40. Possible layout of the GridPix tracker for the ATLAS Inner Detector upgrade for

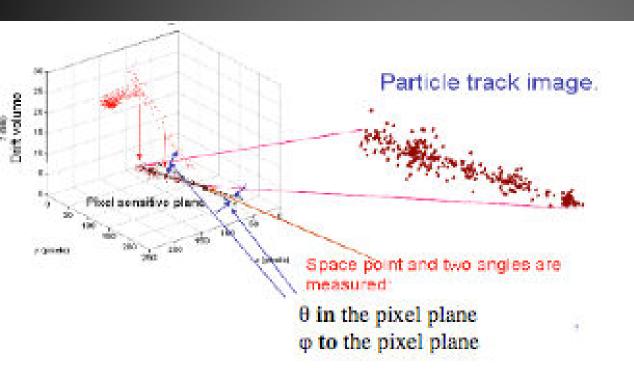


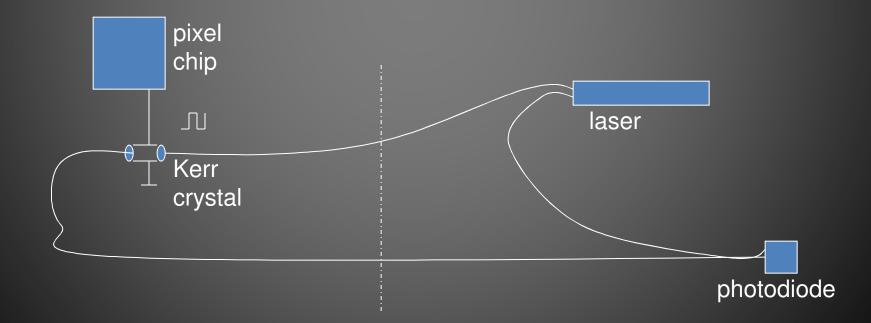
Fig. 41. Principle of the Grid-Pix tracker

First simulation results on momentum resolution by Anatoli Romaniouk

Data Transport

- to outside world
- inter (pixel) chip communication
- Level 1 trigger

status: kapton/aluminium: dominant material for pixel detectors @ sLHC! VCels + optical fiber: not rad hard, much material, much power required



IfLink

A new optical fiber data connection based on interference

- one-way communication
- modulation directly on fiber with LVDS levels
- radiation hard
- low (essentially non) modulation power dissipation at sensor
- no modulator volume & mass

Essential: phase shift modulation in 'thermally poled' (quartz) fibers, or rad-hard LithiumNiobate Xtals (RD24 (1993)).

Final try: optical 'twisted pairs

Optical 'Twisted Pair'
Dual Core fiber

Length L

MachZehnder InterFerence

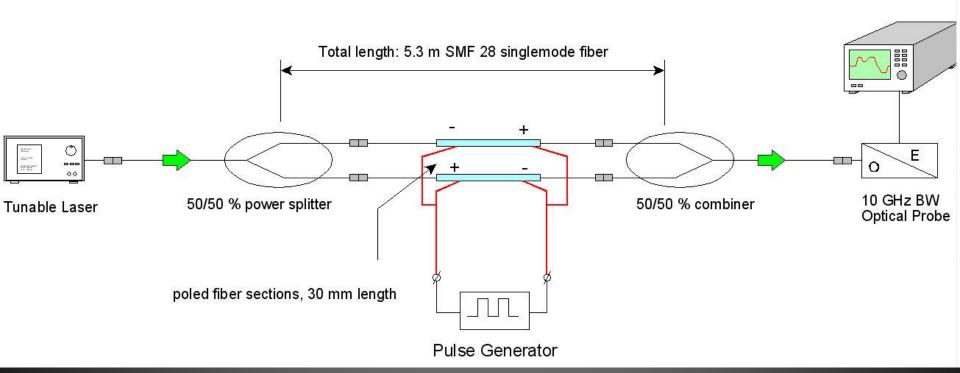
Set-Up moved to Delft Univ. of Technology Results expected Oct 2009:

Phase noise as a function of length L?



Interferometer with poled fibre sections in each branch







Path length tuning

